#### **Features**

- Fast Read Access Time 45 ns
- Low Power CMOS Operation
  - 100  $\mu$ A max. Standby
  - 30 mA max. Active at 5 MHz
- JEDEC Standard Packages
  - 40-Lead 600-mil PDIP
  - 44-Lead PLCC
  - 40-Lead TSOP (10 mm x 14 mm)
- Direct Upgrade from 512K (AT27C516) EPROM
- 5V  $\pm$  10% Power Supply
- High Reliability CMOS Technology
  - 2000V ESD Protection
  - 200 mA Latchup Immunity
- Rapid Programming Algorithm 100 µs/word (typical)
- CMOS and TTL Compatible Inputs and Outputs
- Integrated Product Identification Code
- Commercial and Industrial Temperature Ranges

#### **Description**

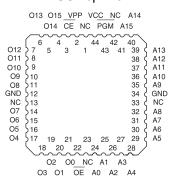
The AT27C1024 is a low-power, high-performance 1,048,576 bit one-time programmable read only memory (OTP EPROM) organized 64K by 16 bits. It requires only one 5V power supply in normal read mode operation. Any word can be accessed in less than 45 ns, eliminating the need for speed reducing WAIT states. The by-16 organization make this part ideal for high-performance 16- and 32-bit microprocessor systems. *(continued)* 

### **Pin Configurations**

Pin Name	Function			
A0 - A15	Addresses			
O0 - O15	Outputs			
CE	Chip Enable			
OE	Output Enable			
PGM	Program Strobe			
NC	No Connect			

Note: Both GND pins must be connected.

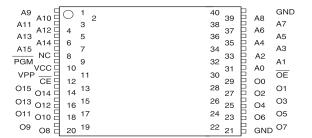
#### **PLCC Top View**



#### PDIP Top View

		· —		,	
VPP	1	0	40	þ	VCC
CE	2		39	þ	PGM
O15	3		38	þ	NC
014	4		37	þ	A15
O13	5		36	þ	A14
012	6		35	þ	A13
011	7		34	Ь	A12
O10	8		33	þ	A11
O9	9		32	Ь	A10
08	10		31	Ь	A9
GND	11		30	þ	GND
07	12		29	þ	A8
O6	13		28	þ	Α7
O5	14		27	þ	A6
04	15		26	þ	A5
О3	16		25	þ	A4
02	17		24	6	АЗ
01	18		23	þ	A2
00	19		22	þ	Α1
ŌE	20		21	þ	A0

### TSOP Top View **Type 1**





1-Megabit (64K x 16) OTP EPROM

AT27C1024

0019I-A-7/97



In read mode, the AT27C1024 typically consumes 15 mA. Standby mode supply current is typically less than 10  $\mu$ A.

The AT27C1024 is available in industry standard JEDEC-approved one-time programmable (OTP) plastic PDIP, PLCC, and TSOP packages. The device features two-line control (CE, OE) to eliminate bus contention in high-speed systems.

With high density 64K word storage capability, the AT27C1024 allows firmware to be stored reliably and to be accessed by the system without the delays of mass storage media.

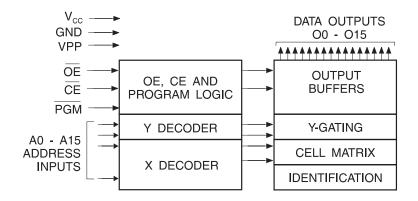
Atmel's 27C1024 have additional features to ensure high quality and efficient production use. The Rapid  $^{\text{TM}}$  Programming Algorithm reduces the time required to program the part and guarantees reliable programming. Programming time is typically only 100  $\mu\text{s/word}$ . The Integrated Product Identification Code electronically identifies the device and manufacturer. This feature is used by industry standard programming equipment to select the proper programming algorithms and voltages.

#### **System Considerations**

Switching between active and standby conditions via the Chip Enable pin may produce transient voltage excursions. Unless accommodated by the system design, these transients may exceed data sheet limits, resulting in device non-conformance. At a minimum, a 0.1  $\mu F$  high frequency, low inherent inductance, ceramic capacitor should be utilized for each device. This capacitor should be connected between the  $V_{CC}$  and Ground terminals of the device, as close to the device as possible. Additionally, to stabilize the supply voltage level on printed circuit boards with large EPROM arrays, a 4.7  $\mu F$  bulk electrolytic capacitor should be utilized, again connected between the  $V_{CC}$  and Ground terminals. This capacitor should be positioned as close as possible to the point where the power supply is connected to the array.



#### **Block Diagram**



#### **Absolute Maximum Ratings\***

Temperature Under Bias55°C to +125°C
Storage Temperature65°C to +150°C
Voltage on Any Pin with Respect to Ground2.0V to +7.0V (1)
Voltage on A9 with Respect to Ground2.0V to +14.0V (1)
V <sub>PP</sub> Supply Voltage with Respect to Ground2.0V to +14.0V <sup>(1)</sup>

\*NOTICE:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note:

Minimum voltage is -0.6V DC which may undershoot to -2.0V for pulses of less than 20 ns. Maximum output pin voltage is V<sub>CC</sub> + 0.75V DC which may overshoot to +7.0V for pulses of less than 20 ns.

#### **Operating Modes**

Mode/Pin	CE	ŌĒ	PGM	Ai	V <sub>PP</sub>	Outputs
Read	$V_{IL}$	$V_{IL}$	X <sup>(1)</sup>	Ai	X	D <sub>OUT</sub>
Output Disable	Х	$V_{IH}$	X	X	X	High Z
Standby	V <sub>IH</sub>	Χ	X	X	X <sup>(5)</sup>	High Z
Rapid Program <sup>(2)</sup>	V <sub>IL</sub>	V <sub>IH</sub>	V <sub>IL</sub>	Ai	V <sub>PP</sub>	D <sub>IN</sub>
PGM Verify	$V_{IL}$	$V_{IL}$	$V_{IH}$	Ai	$V_{PP}$	D <sub>OUT</sub>
PGM Inhibit	$V_{IH}$	Χ	X	X	$V_{PP}$	High Z
Product Identification <sup>(4)</sup>	V <sub>IL</sub>	$V_{IL}$	X	A9 = V <sub>H</sub> <sup>(3)</sup> A0 = V <sub>IH</sub> or V <sub>IL</sub> A1 - A15 = V <sub>IL</sub>	V <sub>CC</sub>	Identification Code

- Notes: 1. X can be V<sub>II</sub> or V<sub>IH</sub>.
  - 2. Refer to Programming Characteristics.
  - 3.  $V_H = 12.0 \pm 0.5 V$ .
  - 4. Two identifier words may be selected. All Ai inputs are held low  $(V_{IL})$ , except A9 which is set to  $V_H$  and A0 which is toggled low  $(V_{IL})$  to select the Manufacturer's Identification word and high  $(V_{IH})$  to select the Device Code word.
  - 5. Standby  $V_{CC}$  current ( $I_{SB}$ ) is specified with  $V_{PP} = V_{CC}$ .  $V_{CC} > V_{PP}$  will cause a slight increase in  $I_{SB}$ .



# 查询"AT27C1024-12JI"供应商 DC and AC Operating Conditions for Read Operation

			AT27C1024								
		-45	-55	-70	-90	-12	-15				
Operating	Com.	0°C - 70°C									
Temperature (Case)	Ind.	-40°C - 85°C									
V <sub>CC</sub> Power Supply		5V ± 10%									

#### **DC and Operating Characteristics for Read Operation**

Symbol	Parameter	Condition	Min	Max	Units
ILI	Input Load Current	V <sub>IN</sub> = 0V to V <sub>CC</sub>		± 1	μΑ
I <sub>LO</sub>	Output Leakage Current	V <sub>OUT</sub> = 0V to V <sub>CC</sub>		± 5	μΑ
IPP1 <sup>(2)</sup>	V <sub>PP</sub> <sup>(1))</sup> Read/Standby Current	$V_{PP} = V_{CC}$		10	μΑ
	V <sub>CC</sub> <sup>(1)</sup> Standby Current	$I_{SB1}$ (CMOS), $\overline{CE} = V_{CC~\pm} 0.3V$		100	μΑ
I <sub>SB</sub>		$I_{SB2}$ (TTL), $\overline{CE}$ = 2.0 to $V_{CC}$ + 0.5V		1	mA
Icc	V <sub>CC</sub> Active Current	$f = 5 \text{ MHz}, I_{OUT} = 0 \text{ mA}, \overline{CE} = V_{IL}$		30	mA
V <sub>IL</sub>	Input Low Voltage		-0.6	0.8	V
V <sub>IH</sub>	Input High Voltage		2.0	V <sub>CC</sub> + 0.5	V
V <sub>OL</sub>	Output Low Voltage	I <sub>OL</sub> = 2.1 mA		0.4	V
V <sub>OH</sub>	Output High Voltage	I <sub>OH</sub> = -400 μA	2.4		V

Note: 1.  $V_{CC}$  must be applied simultaneously or before  $V_{PP}$  and removed simultaneously or after  $V_{PP}$ 

2.  $V_{PP}$  may be connected directly to  $V_{CC}$ , except during programming. The supply current would then be the sum of  $I_{CC}$  and

### **AC Characteristics for Read Operation**

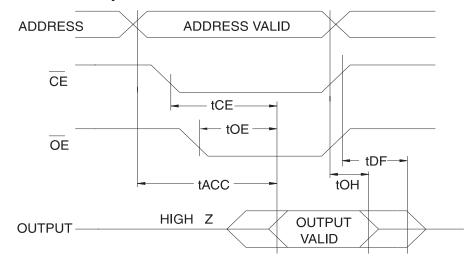
			AT27C1024												
			-4	45	-55		-70		-90		-12		-15		
Symbol	Parameter	Condition	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Units
t <sub>ACC</sub> <sup>(3)</sup>	Address to Output Delay	CE = OE = V <sub>IL</sub>		45		55		70		90		120		150	ns
t <sub>CE</sub> <sup>(2)</sup>	CE to Output Delay	OE = V <sub>IL</sub>		45		55		70		90		120		150	ns
t <sub>OE</sub> <sup>(2)(3)</sup>	OE to Output Delay	CE = V <sub>IL</sub>		20		25		25		30		35		50	ns
t <sub>DF</sub> <sup>(4)(5)</sup>	OE or CE High to Output Float, whichever occurred first			20		25		25		30		30		40	ns
t <sub>OH</sub>	Output Hold from Address, CE or OE, whichever occurred first		7		7		7		0		0		0		ns

Notes: 2, 3, 4, 5. - see AC Waveforms for Read Operation.





### AC Waveforms for Read Operation<sup>(1)</sup>



- Notes: 1. Timing measurement reference level is 1.5V for -45 and -55 devices. Input AC drive levels are  $V_{IL} = 0.0V$  and  $V_{IH} = 3.0V$ . Timing measurement reference levels for all other speed grades are V<sub>OL</sub> = 0.8V and V<sub>OH</sub> = 2.0V. Input AC drive levels are  $V_{IL} = 0.45V$  and  $V_{IH} = 2.4V$ .
  - 2. OE may be delayed up to t<sub>CE</sub> t<sub>OE</sub> after the falling edge of CE without impact on t<sub>CE</sub>.
  - 3.  $\overline{\text{OE}}$  may be delayed up to  $t_{ACC}$   $t_{OE}$  after the address is valid without impact on  $t_{ACC}$ .
  - This parameter is only sampled and is not 100% tested.
  - Output float is defined as the point when data is no longer driven.

#### Pin Capacitance

 $(f = 1 \text{ MHz } T = 25^{\circ}\text{C})^{(1)}$ 

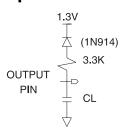
	Тур	Max	Units	Conditions
C <sub>IN</sub>	4	10	pF	V <sub>IN</sub> = 0V
C <sub>OUT</sub>	8	12	pF	V <sub>OUT</sub> = 0V

Note: 1. Typical values for nominal supply voltage. This parameter is only sampled and is not 100% tested.

### **Input Test Waveforms and Measurement Levels**

#### 3.0V AC AC **DRIVING** 1.5V **MEASUREMENT** For -45 and -55 **LEVELS LEVEL Devices Only** 0.0V 2.4V AC **DRIVING MEASUREMENT** For -70 and slower **LEVELS Devices Only LEVEL** 0.45V

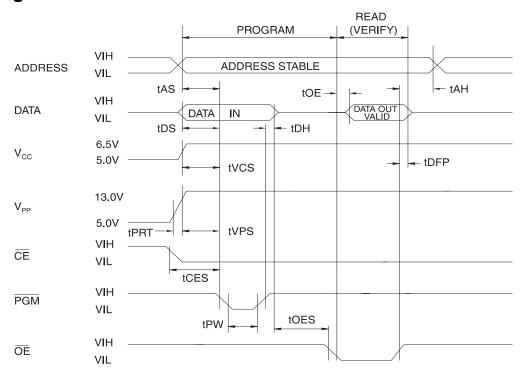
#### **Output Test Load**



 $C_L = 100 pF$  including jig capacitance except -45 and -55 devices, where  $C_L = 30$  pF.

Note:

## 查询"AT27C1024-12JI"供应商(1) Programming Waveforms(1)



Notes: 1.

- 1. The Input Timing Reference is 0.8V for  $V_{IL}$  and 2.0V for  $V_{IH}$ .
- 2. t<sub>OE</sub> and t<sub>DFP</sub> are characteristics of the device but must be accommodated by the programmer.
- 3. When programming the AT27C1024 a 0.1  $\mu$ F capacitor is reqired across  $V_{PP}$  and ground to suppress sputious voltage transients.

#### **DC Programming Characteristics**

 $TA = 25 \pm 5 \times C$ ,  $VCC = 6.5 \pm 0.25 V$ ,  $VPP = 13.0 \pm 0.25 V$ 

			L	imits	
Symbol	Parameter	Test Conditions	Min	Max	Units
ILI	Input Load Current	$V_{IN} = V_{IL}, V_{IH}$		±10	μА
V <sub>IL</sub>	Input Low Level		-0.6	0.8	V
V <sub>IH</sub>	Input High Level		2.0	V <sub>CC</sub> + 0.1	V
V <sub>OL</sub>	Output Low Voltage	I <sub>OL</sub> = 2.1 mA		0.4	V
V <sub>OH</sub>	Output High Voltage	I <sub>OH</sub> = -400 μA	2.4		V
I <sub>CC2</sub>	V <sub>CC</sub> Supply Current (Program and Verify)			50	mA
I <sub>PP2</sub>	V <sub>PP</sub> Supply Current	CE = PGM = V <sub>IL</sub>		30	mA
V <sub>ID</sub>	A9 Product Identification Voltage		11.5	12.5	V



# 查询"AT27C1024-12JI"供应商 AC Programming Characteristics

 $T_A = 25 \pm 5^{\circ}C, \ V_{CC} = 6.5 \pm 0.25V, \ V_{PP} = 13.0 \pm 0.25V$ 

			Lir	nits	
Symbol	Parameter	Test Conditions <sup>(1)</sup>	Min	Max	Units
t <sub>AS</sub>	Address Setup Time		2		μs
t <sub>CES</sub>	CE Setup Time		2		μs
t <sub>OES</sub>	OE Setup Time	Input Rise and Fall Times	2		μs
t <sub>DS</sub>	Data Setup Time	(10% to 90%) 20ns	2		μs
t <sub>AH</sub>	Address Hold Time	Input Pulse Levels	0		μs
t <sub>DH</sub>	Data Hold Time	0.45V to 2.4V	2		μs
t <sub>DFP</sub>	OE High to Output Float Delay <sup>(2)</sup>	Input Timing Reference Level	0	130	ns
t <sub>VPS</sub>	V <sub>PP</sub> Setup Time	0.8V to 2.0V	2		μs
t <sub>VCS</sub>	V <sub>CC</sub> Setup Time	Output Timing Reference Level	2		μs
t <sub>PW</sub>	PGM Program Pulse Width <sup>(3)</sup>	0.8V to 2.0V	95	105	μs
t <sub>OE</sub>	Data Valid from OE			150	ns
t <sub>PRT</sub>	V <sub>PP</sub> Pulse Rise Time During Programming		50		ns

- Notes: 1.  $V_{CC}$  must be applied simultaneously or before  $V_{PP}$  and removed simultaneously or after  $V_{PP}$ 
  - This parameter is only sampled and is not 100% tested. Output Float is defined as the point where data is no longer driven — see timing diagram.
  - 3. Program Pulse width tolerance is 100  $\mu$ sec  $\pm$  5%.

## Atmel's 27C1024 Integrated Product Identification Code

		Pins									Hex
Codes	Α0	A0 015-08 07 06 05 04 03 02 01 00							Data		
Manufacturer	0	0	0	0	0	1	1	1	1	0	001E
Device Type	1	1 0 1 1 1 0 0 1								00F1	

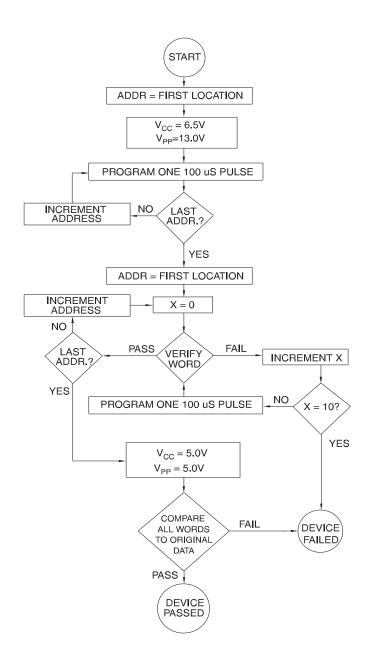




#### **Rapid Programming Algorithm**

A 100  $\mu$ s  $\overline{PGM}$  pulse width is used to program. The address is set to the first location.  $V_{CC}$  is raised to 6.5V and  $V_{PP}$  is raised to 13.0V. Each address is first programmed with one 100  $\mu$ s  $\overline{PGM}$  pulse without verification. Then a verification / reprogramming loop is executed for each address. In the event a word fails to pass verification, up to 10 successive 100  $\mu$ s pulses are applied with a verification

after each pulse. If the word fails to verify after 10 pulses have been applied, the part is considered failed. After the word verifies properly, the next address is selected until all have been checked.  $V_{PP}$  is then lowered to 5.0V and  $V_{CC}$  to 5.0V. All words are read again and compared with the original data to determine if the device passes or fails.



# 查询"AT27C1024-12JI"供应商 Ordering Information

t <sub>ACC</sub>	Ico	(mA)			
(ns)	Active	Standby	Ordering Code	Package	<b>Operation Range</b>
45	30	30 0.1 AT27C1024-45JC AT27C1024-45PC AT27C1024-45VC		44J 40P6 40V	Commercial (0°C to 70°C)
	30	0.1	AT27C1024-45JI AT27C1024-45PI AT27C1024-45VI	44J 40P6 40V	Industrial (-40°C to 85°C)
55	30	0.1	AT27C1024-55JC AT27C1024-55PC AT27C1024-55VC	44J 40P6 40V	Commercial (0°C to 70°C)
	30	0.1	AT27C1024-55JI AT27C1024-55PI AT27C1024-55VI	44J 40P6 40V	Industrial (-40°C to 85°C)
70	30	0.1	AT27C1024-70JC AT27C1024-70PC AT27C1024-70VC	44J 40P6 40V	Commercial (0°C to 70°C)
	30	0.1	AT27C1024-70JI AT27C1024-70PI AT27C1024-70VI	44J 40P6 40V	Industrial (-40°C to 85°C)
90	30	0.1	AT27C1024-90JC AT27C1024-90PC AT27C1024-90VC	AT27C1024-90PC 40P6	
	30	0.1	AT27C1024-90JI AT27C1024-90PI AT27C1024-90VI	44J 40P6 40V	Industrial (-40°C to 85°C)
120	30	0.1	AT27C1024-12JC AT27C1024-12PC AT27C1024-12VC	44J 40P6 40V	Commercial (0°C to 70°C)
	30	0.1	AT27C1024-12JI AT27C1024-12PI AT27C1024-12VI	44J 40P6 40V	Industrial (-40°C to 85°C)
150	30	0.1	AT27C1024-15JC AT27C1024-15PC AT27C1024-15VC	44J 40P6 40V	Commercial (0°C to 70°C)
	30	0.1	AT27C1024-15JI AT27C1024-15PI AT27C1024-15VI	44J 40P6 40V	Industrial (-40°C to 85°C)

Package Type	
44J	44-Lead, Plastic J-Leaded Chip Carrier (PLCC)
40P6	40-Lead, 0.600" Wide, Plastic Dual Inline Package (PDIP)
40V	40-Lead, Plastic Thin Small Outline Package (TSOP) 10 x 14 mm

